

Electronic Patent Application Fee Transmittal

Application Number:	10591476
Filing Date:	01-Sep-2006
Title of Invention:	Copper film deposition method
First Named Inventor/Applicant Name:	Yasuhiko Kojima
Filer:	Michael A. Makuch/Cynthia Johnson
Attorney Docket Number:	33082M343

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
-------------	----------	----------	--------	----------------------

Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Filing a brief in support of an appeal	1402	1	540	540
--	------	---	-----	-----

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1110	1110
Miscellaneous:				
Total in USD (\$)				1650